

# 100mA - 150mA, 75V Surface Mount Switching Diode

#### **FEATURES**

- Low power loss, high efficiency
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant

#### **APPLICATIONS**

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- On-board DC/DC converter

#### **MECHANICAL DATA**

- Molding compound meets UL 94HB flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: Indicated by cathode band

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	100, 150	mA	
$V_{RRM}$	75	V	
Configuration	Single die		









ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		SYMBOL	TS4148	TS4148	TS4148	UNIT
Package			0603	0805	1206	
			(Ceramics)	(Ceramics)	(Ceramics)	
Repetitive peak reverse voltage		$V_{RRM}$	75			V
Forward current		I <sub>F</sub>	100	150	150	mA
Non-repetitive peak forward surge current	t = 1s		0.4	0.5		Α
	t = 8.3ms	I <sub>FSM</sub>	0.8	2.0		Α
Junction temperature range		TJ	-55 to +150	-55 to +175	-55 to +150	°C
Storage temperature range		T <sub>STG</sub>	-55 to +150	-55 to +175	-55 to +150	°C



THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-ambient thermal resistance	R <sub>eJA</sub>	375	°C/W	

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage <sup>(1)</sup>	0603, 1206 (Ceramics)	I <sub>F</sub> = 10mA, T <sub>J</sub> = 25°C		-	1.00	V
	0805 (Ceramics)	I <sub>F</sub> = 100mA, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.00	V
	0603, 1206 (Ceramics)	I <sub>F</sub> = 100mA, T <sub>J</sub> = 25°C		-	1.25	V
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>		$V_R = 20V, T_J = 25^{\circ}C$		1	25	nA
		$V_R = 75V, T_J = 25^{\circ}C$	l <sub>R</sub>	1	5	μΑ
Reverse recovery time		$I_F = 10\text{mA}, I_R = 10\text{mA},$ $R_L = 100\Omega$	t <sub>rr</sub>	-	4	ns
Junction capacitance		1MHz, $V_R = 0V$	C <sub>J</sub>	-	4	pF

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
TS4148 RCG	0603 (Ceramics)	10,000 / 13" Tape & Reel	
TS4148 RBG	0805 (Ceramics)	10,000 / 13" Tape & Reel	
TS4148 RAG	1206 (Ceramics)	10,000 / 13" Tape & Reel	



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Typical Reverse Characteristics

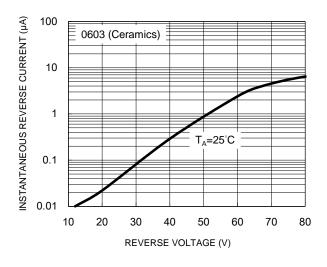


Fig.3 Typical Reverse Characteristics

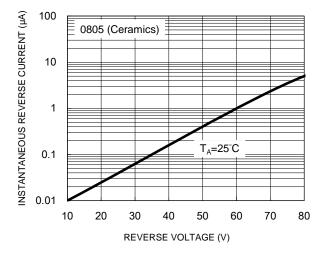


Fig.5 Typical Reverse Characteristics

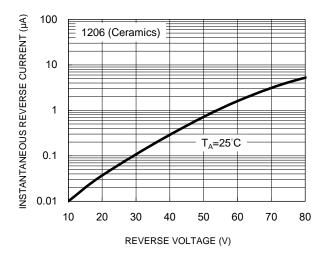


Fig.2 Typical Forward Characteristics

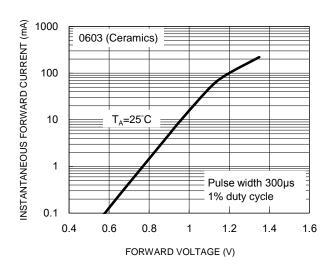


Fig.4 Typical Forward Characteristics

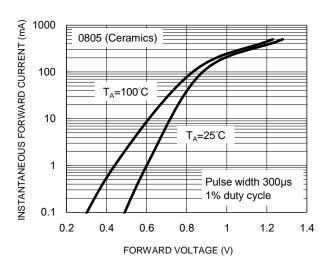
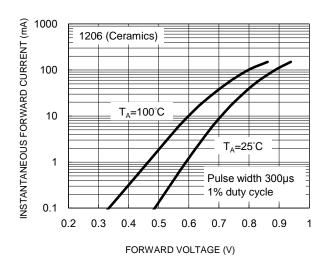


Fig.6 Typical Forward Characteristics





#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.7 Admissible Power Dissipation Curve

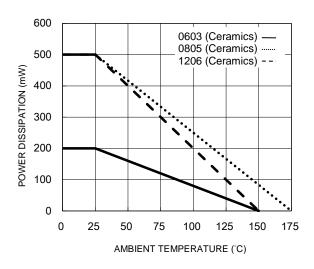
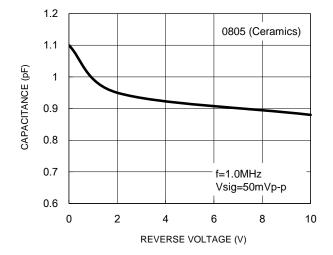


Fig.9 Typical Junction Capacitance



**Fig.8 Typical Junction Capacitance** 

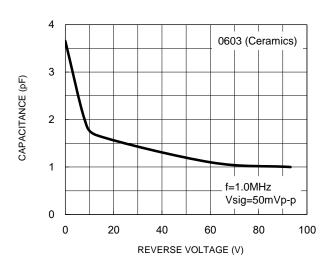
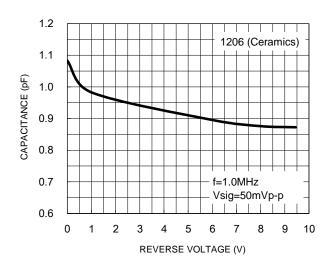


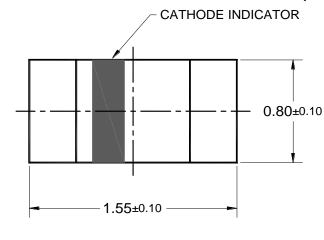
Fig.10 Typical Junction Capacitance

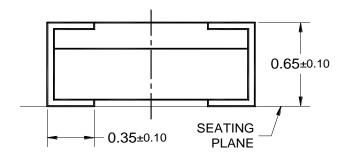


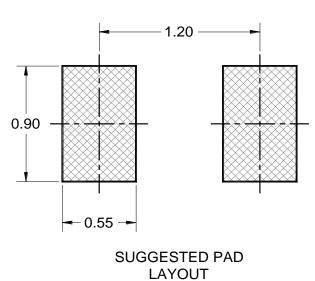


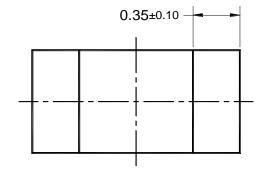
# **PACKAGE OUTLINE DIMENSIONS**

## 0603 (Ceramics)









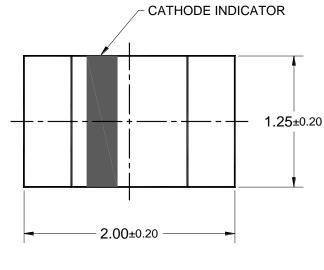
NOTES: UNLESS OTHERWISE SPECIFIED

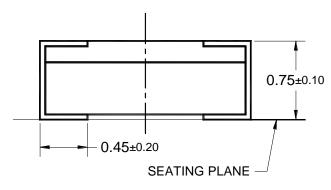
- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. PACKAGE SIZE CODE REFERENCE: EIA (inch) NAME: 0603 (0.063in x 0.031in) IEC (metric) NAME: 1608 (1.6mm x0.8mm)
- 3. DWG NO. REF: HQ2SD07-0603C-048 REV A.

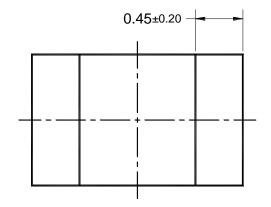


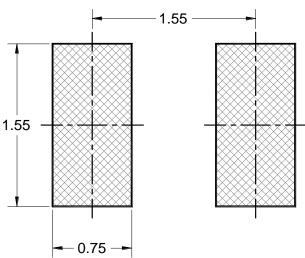
# **PACKAGE OUTLINE DIMENSIONS**

# 0805 (Ceramics)









SUGGESTED PAD LAYOUT

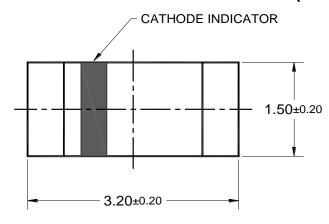
NOTES: UNLESS OTHERWISE SPECIFIED

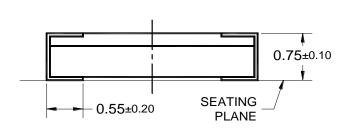
- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. PACKAGE SIZE CODE REFERENCE: EIA (inch) NAME: 0805 (0.079in x 0.049in) IEC (metric) NAME: 2012 (2.0mm x1.25mm)
- 3. DWG NO. REF: HQ2SD07-0805-042 REV A.

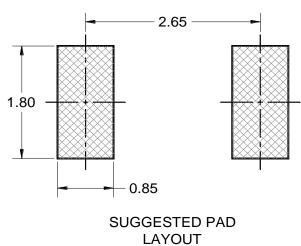


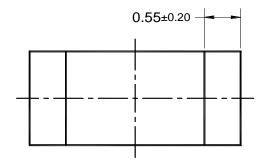
# **PACKAGE OUTLINE DIMENSIONS**

## 1206 (Ceramics)









NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. PACKAGE SIZE CODE REFERENCE: EIA (inch) NAME: 1206 (0.126in x 0.063in) IEC (metric) NAME: 3216 (3.2mm x1.6mm)
- 3. DWG NO. REF: HQ2SD07-1206C-049 REV A.



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